### Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
John M. Cohn	04/10/2008
Leah M. Pastel	03/31/2008
Gustavo E. Tellez	04/14/2008

#### **RECEIVING PARTY DATA**

Name:	International Business Machines Corporation	
Street Address:	New Orchard Road	
City:	Armonk	
State/Country:	NEW YORK	
Postal Code:	10504	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12103217

#### **CORRESPONDENCE DATA**

Fax Number: (513)241-6234

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 5132412324

Email: wallen@whepatent.com

Correspondent Name: Wood, Herron & Evans LLP

Address Line 1: 441 Vine Street
Address Line 2: Suite 2700

Address Line 4: Cincinnati, OHIO 45202

ATTORNEY DOCKET NUMBER:	BUR920080059US1
NAME OF SUBMITTER:	William R. Allen

Total Attachments: 6 source=ass#page1.tif

PATENT REEL: 020804 FRAME: 0557

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PATENT REEL: 020804 FRAME: 0558

PATENT DOCKET NO. BUR920080059US1

#### PATENT ASSIGNMENT FORM

For and in consideration of good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor acknowledges his/her prior and ongoing obligation to sell, assign, and transfer, and agrees to sell, assign, and transfer the entire world wide right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements conceived during and within the scope of his/her employment, and further acknowledges that he/she has sold, assigned, and transferred, and hereby sells, assigns, and transfers, unto:

INTERNATIONAL BUSINESS MACHINES CORPORATION ("IBM"), Armonk, New York 10504

a corporation of New York, and IBM desires to acquire all right, title, and interest, in and to the certain inventions (identified below), applications, and any United States and foreign patents to be obtained therefor relating to:

# Title of Invention for United States Patent METHODS FOR DESIGNING A PRODUCT CHIP A PRIORI FOR DESIGN SUBSETTING, FEATURE ANALYSIS, AND YIELD LEARNING

as set forth in United States Patent Applica inventor signature below, and further identi (select one)		gned inventor on the date indicated by each ber BUR920080059US1 Filed on
which may issue on any such application of extensions thereof, to be held and enjoyed	r for said invention therein disc by, its successors, legal repre-	sions or continuations thereof and in and to rights of priority to be obtained therefor losed, including any and all reissues or sentatives and assigns to the full end of the sfully and entirely as would have been held
Each undersigned inventor hereby sufficient	150 and	

each undersigned inventor nereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all such Letters Patent to IBM, its successors and assigns, in accordance herewith;

Each undersigned inventor warrants and covenants that he/she has the full and unencumbered right to sell and assign the interests hereby sold and assigned and that he/she has not executed and will not execute any document or instrument in conflict herewith;

Each undersigned inventor further covenants and agrees that he/she, upon the request and at the expense of the IBM, will execute and deliver any papers, make all rightful oaths, testify in any legal proceeding relating to said inventions and improvements, communicate to the IBM all facts known to the undersigned relating to such inventions and improvements and the history thereof; and perform all other lawful acts deemed necessary or desirable by IBM, and its legal representatives, to secure, maintain, and enforce patent protection for such inventions and improvements and for vesting title to such inventions and improvements in the IBM, and in particular to perfect title to said above-identified certain inventions, and applications including divisions and continuations thereof, and any and all Letters Patent which may be granted therefor or thereon, including reissues, extensions, or counterparts;

Each undersigned inventor hereby grants the IBM and the firm of the power to insert in this Assignment any further identification that may be necessary or desirable for recordation of this Assignment.

This assignment is governed by the substantive laws of the state of New York.

Page 1 of 2

PATENT REEL: 020804 FRAME: 0559

		EXECUTED BY INVENTOR 1 of 3
Signature:	1 1666	Date: 4/10/06
	(John M. Cohn)	Executed by Inventor 2 of 2
<u>,</u>	•	
Signature:	(Leah M. Pastel)	Date:
		Executed by Inventor 3 of 3
Signature:	(Gustavo E. Tellez)	Date:

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### Title of Invention for United States Patent METHODS FOR DESIGNING A PRODUCT CHIP A PRIORI FOR DESIGN SUBSETTING, FEATURE ANALYSIS, AND YIELD LEARNING

as set forth in United States Patent Application execute inventor signature below, and further identified by <b>Atto</b> (select one)  accounted concurrently herewith <b>or</b>	rney Docket Number Bl	JR920080059US1	by each
for and to said United States Patent Application includi any and all Letters Patent of the United States and fore which may issue on any such application or for said invextensions thereof, to be held and enjoyed by, its succ term or terms for which any and all such Letters Patent and enjoyed by the undersigned had this Assignment r	eign patents and all rights vention therein disclosed, essors, legal representati t may be granted as fully	of priority to be obtained then including any and all reissues ves and assigns to the full end	efor s or d of the
Each undersigned inventor hereby authorizes and requany and all such Letters Patent to IBM, its successors			issue

Each undersigned inventor warrants and covenants that he/she has the full and unencumbered right to sell and assign the interests hereby sold and assigned and that he/she has not executed and will not execute any document or instrument in conflict herewith:

Each undersigned inventor further covenants and agrees that he/she, upon the request and at the expense of the IBM, will execute and deliver any papers, make all rightful oaths, testify in any legal proceeding relating to said inventions and improvements, communicate to the IBM all facts known to the undersigned relating to such inventions and improvements and the history thereof; and perform all other lawful acts deemed necessary or desirable by IBM, and its legal representatives, to secure, maintain, and enforce patent protection for such inventions and improvements and for vesting title to such inventions and improvements in the IBM, and in particular to perfect title to said above-identified certain inventions, and applications including divisions and continuations thereof, and any and all Letters Patent which may be granted therefor or thereon, including reissues, extensions, or counterparts;

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		Executed by investion 1 of 3	
Signature:(John M.	(John M. Cohn)	Date:	
	(com in com)	Executed by Inventor 2 of 2	
Signature:	Flah M. Pastel (Leah M. Pastel)	Date:	3/31/2008
		Executed by Inventor 3 of 3	
Signature:	(Gustavo F. Tellez)	Date:	

#### PATENT ASSIGNMENT FORM

For and in consideration of good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor acknowledges his/her prior and ongoing obligation to sell, assign, and transfer, and agrees to sell, assign, and transfer the entire world wide right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements conceived during and within the scope of his/her employment, and further acknowledges that he/she has sold, assigned, and transferred, and hereby sells, assigns, and transfers, unto:

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as set forth in United States Patent Application executed by each undersigned inventor on the date indicated by eac inventor signature below, and further identified by <b>Attorney Docket Number BUR920080059US1</b> (select one) according to the concurrently herewith <b>or</b> Serial No Filed on
for and to said United States Patent Application including any and all divisions or continuations thereof and in and to any and all Letters Patent of the United States and foreign patents and all rights of priority to be obtained therefor which may issue on any such application or for said invention therein disclosed, including any and all reissues or extensions thereof, to be held and enjoyed by, its successors, legal representatives and assigns to the full end of the term or terms for which any and all such Letters Patent may be granted as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made;
Each undersigned inventor hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all such Letters Patent to IBM, its successors and assigns, in accordance herewith;

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		Executed by inventor 1 of 3
Signature:	(John M. Cohn)	Date:
		Executed by inventor 2 of 2
Signature:	(Leah M. Pastel)	Date:
		Executed by Inventor 3 of 3
Signature:	(Gustavo E. Tellez)	Date: 4/14/2008
	1	

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**RECORDED: 04/15/2008**